



Docket No.: NE-70085US
PRI.001

HPW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of

Hiroyuki KUNISHIMA, et al.

Serial No.: 10/613,069

Group Art Unit: 2818

Filed: July 7, 2003

Examiner: Huynh, Andy

For: SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD
THEREOF

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

PRIOR ART SUBMISSION

Sir:

For the possible benefit of anyone subsequently evaluating the scope and/or validity of the above patent, it is respectfully requested that the following references, cited in the corresponding Chinese Application, be placed in the file wrapper:

1. U.S. Patent No. 6,391,774, issued May 21, 2002.
2. Chinese Office Action, dated July 15, 2005, with an English translation thereof.

The undersigned has not reviewed the teachings of these references in detail and, thus, makes no representations concerning their relevancy or materiality.

Respectfully submitted,

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